

NCE N-Channel Enhancement Mode Power MOSFET



The NCE40H30D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

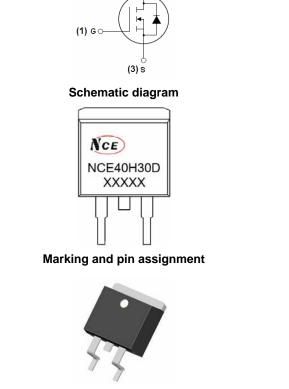
- V_{DS} =40V ,I_D =300A
 - $R_{DS(ON)} < 1.8m\Omega @ V_{GS}=10V$
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



(2) D

TO-263-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE40H30D	NCE40H30D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	40	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	Ι _D	300	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	212	A
Pulsed Drain Current	I _{DM}	840	A
Maximum Power Dissipation	PD	350	W
Derating factor		2.33	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	2500	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	0.43	°C/W



Electrical Characteristics (T_A=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·	•	•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.3	1.8	2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =150A	-	1.4	1.8	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =150A	-	100	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	11635	-	PF
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V, F=1.0MHz	-	1360	-	PF
Reverse Transfer Capacitance	C _{rss}		-	1229	-	PF
Switching Characteristics (Note 4)	·	·				
Turn-on Delay Time	t _{d(on)}		-	42	-	nS
Turn-on Rise Time	tr	V_{DD} =20V,RL=15 Ω ,	-	41	-	nS
Turn-Off Delay Time	t _{d(off)}	R _G =2.5Ω,V _{GS} =10V	-	150	-	nS
Turn-Off Fall Time	t _f		-	70	-	nS
Total Gate Charge	Qg		-	249	-	nC
Gate-Source Charge	Q _{gs}	I _D =150A,V _{DD} =20V,V _{GS} =10V	-	40	-	nC
Gate-Drain Charge	Q _{gd}		-	80	-	nC
Drain-Source Diode Characteristics	·		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =150A	-	0.85	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	300	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 300A	-	55		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	180		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

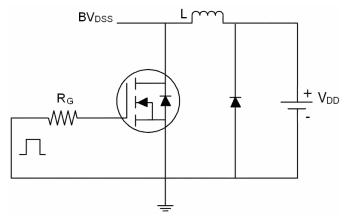
5. EAS condition: Tj=25 $^\circ\!\mathrm{C},V_{DD}$ =20V,V_G=10V,L=0.5mH,Rg=25 Ω



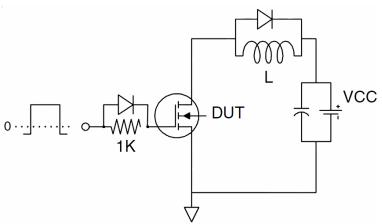
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Test circuit

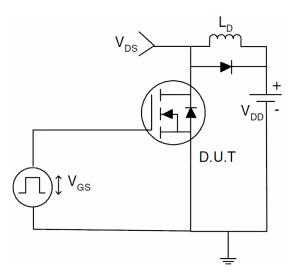
1) E_{AS} test Circuits



2) Gate charge test Circuit:

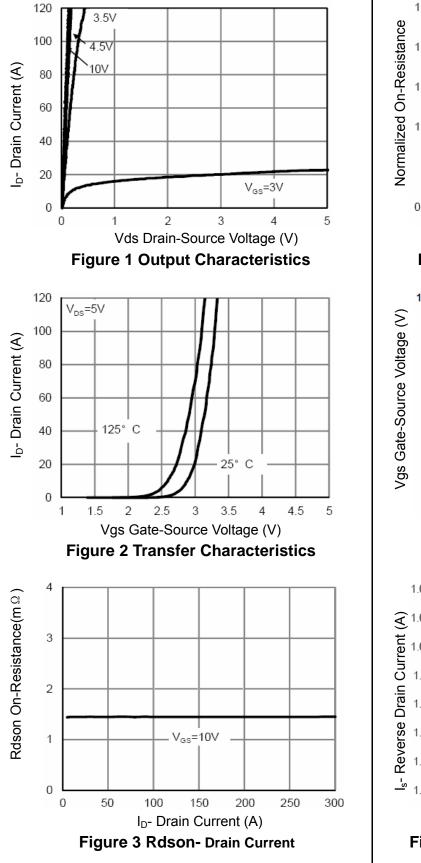


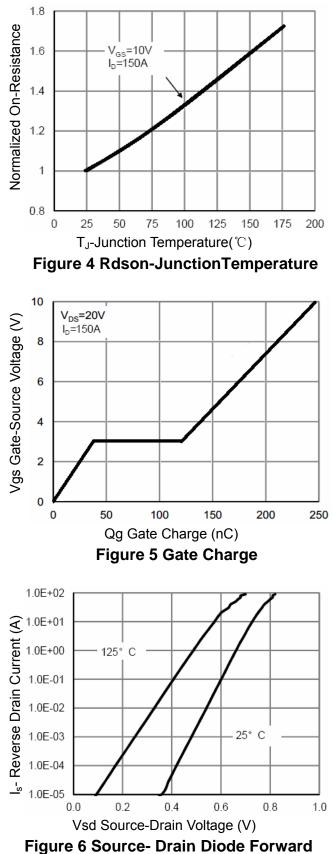
3) Switch Time Test Circuit:





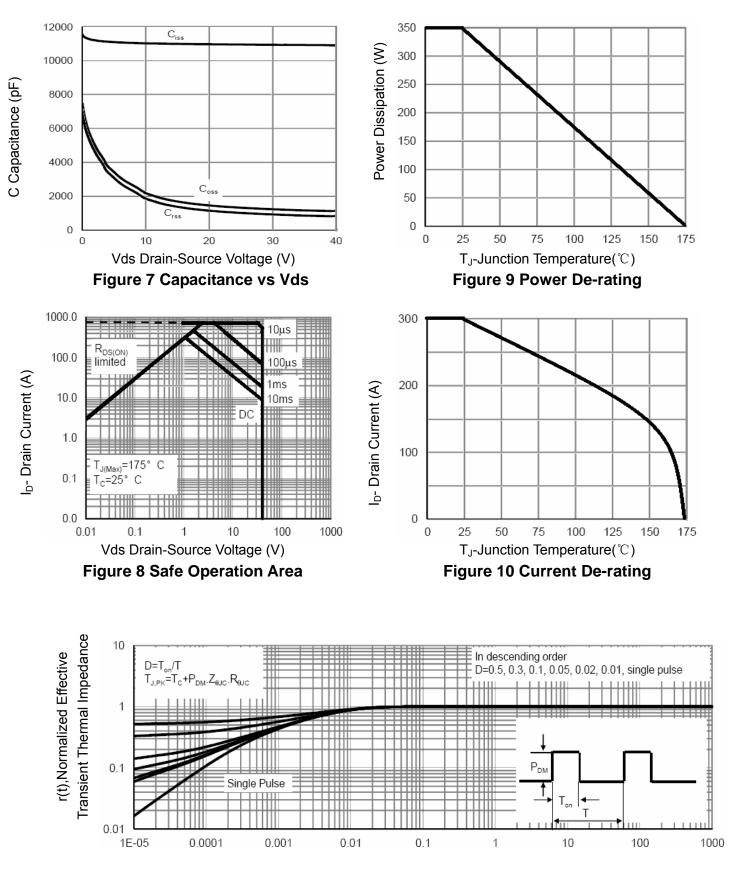
Typical Electrical and Thermal Characteristics (Curves)







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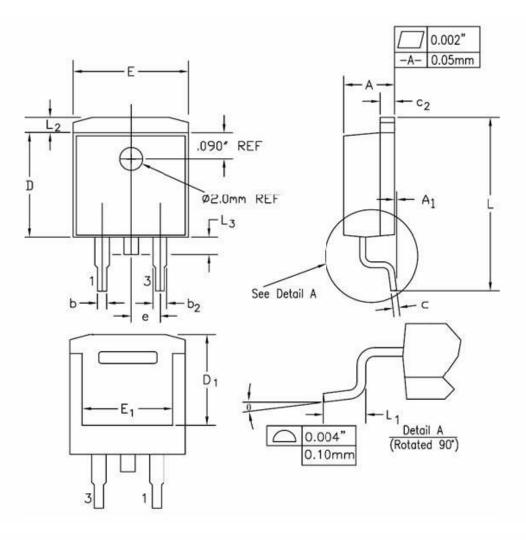


Square Wave Pluse Duration (sec) Figure 11 Normalized Maximum Transient Thermal Impedance



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TO-263-2L Package Information



SYMBOL	INCHES		MILLIMETERS		NOTES
STINDUL	MIN	MAX	MIN	MAX	NOTES
A	0.170	0.180	4.32	4.57	
A1	-	0.010	-	0.25	
b	0.028	0.037	0.71	0.94	
b2	0.045	0.055	1.15	1.40	
С	0.018	0.024	0.46	0.61	
c2	0.048	0.055	1.22	1.40	
D	0.350	0.370	8.89	9.40	
D1	0.315	0.324	8.01	8.23	
E	0.395	0.405	10.04	10.28	
E1	0.310	0.318	7.88	8.08	
e	0.100 BSC.		2.54 BSC.		
L	0.580	0.620	14.73	15.75	
L1	0.090	0.110	2.29	2.79	
L2	0.045	0.055	1.15	1.39	
L3	0.050	0.070	1.27	1.77	
θ	0°	8°	0°	8°	



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